

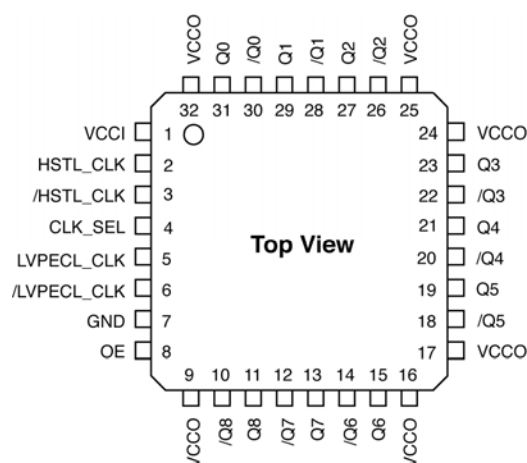
Ordering Information⁽¹⁾

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY89809ALTZ ⁽³⁾	T32-1	Commercial	SY89809ALTZ with Pb-Free bar-line indicator	Matte-Sn Pb-Free
SY89809ALTZTR ^(2, 3)	T32-1	Commercial	SY89809ALTZ with Pb-Free bar-line indicator	Matte-Sn Pb-Free

Notes:

1. Contact factory for die availability. Dice are guaranteed at $T_A = 25^\circ\text{C}$, DC Electricals only.
2. Tape and Reel.
3. Pb-Free package is recommended for new designs.

Pin Configuration



32-Pin TQFP (T32-1)

Pin Description

Pin Number	Pin Name	Type	Pin Function
2, 3	HSTL_CLK, /HSTL_CLK	HSTL Input	Differential clock input selected by CLK_SEL. Can be left floating if not selected. Floating input, if selected, produces a LOW at HSTL_CLK and a HIGH at /HSTL_CLK. HSTL input signal requires external termination 50Ω-to-ground.
5, 6	LVPECL_CLK, /LVPECL_CLK	LVPECL Input	Differential clock input selected by CLK_SEL. Can be left floating if not selected. Floating input, if selected, produces a LOW at LVPECL_CLK and a HIGH at /LVPECL_CLK. Non-inverted input has a 75kΩ pull-down. Inverted input has a 75kΩ pull-down and a 37.5kΩ pull-up.
4	CLK_SEL	LVTTTL Input	Selected HSTL_CLK input when LOW and LVPECL_CLK output when HIGH. 37.5kΩ pull-up.
8	OE	LVTTTL Input	Enable input synchronized internally to prevent glitching of the Q0-Q8 and /Q0-/Q8 outputs. OE high-to-low transition ensures outputs remain disabled during the next clock cycle. OE low-to-high transition enables normal operation of the next input clock. 37.5kΩ pull-up.
31, 29, 27, 23, 21, 19, 15, 13, 11	Q0 – Q8	HSTL Output	Differential clock outputs from HSTL_CLK when CLK_SEL = LOW and and from LVPECL outputs when CLK_SEL = HIGH. HSTL outputs must be terminated with 50Ω to GND. Q0-Q8 outputs are static LOW when OE = LOW. Unused output pairs may be left floating.

Pin Description (Continued)

Pin Number	Pin Name	Type	Pin Function
30, 28, 26, 22, 20, 18, 14, 12, 10	/Q0 – /Q8	HSTL Output	Differential clock outputs from HSTL_CLK when CLK_SEL = LOW and from LVPECL outputs when CLK_SEL = HIGH. HSTL outputs must be terminated with 50Ω to GND. /Q0-/Q8 outputs are static HIGH when OE = LOW. Unused output pairs may be left floating.
1	VCCI	VCC Core Power	Core V _{CC} connected to 3.3V supply. Bypass with 0.1μF in parallel with 0.01μF low ESR capacitors as close to V _{CCI} pin as possible.
9, 16, 17, 24, 25, 32	VCCO	VCC Output Power	Output Buffer VCC connected to 1.8V supply. Bypass with 0.1μF in parallel with 0.01μF low ESR capacitors as close to V _{CCO} pins as possible. All V _{CCO} pins should be connected together on the PCB.
7	GND	Ground	Ground.

Absolute Maximum Ratings⁽¹⁾

Input Voltage (V_{IN})	–0.5V to V_{CCI}
V_{CC} Pin Potential to Ground Pin (V_{CCI} , V_{CCO})	–0.5V to +4.0V
Output Current (I_{OUT})	
Continuous	50mA
Surge	100mA
Lead Temperature (soldering, 20sec.)	260°C
Storage Temperature (T_s)	–65°C to +150°C

Operating Ratings⁽²⁾

Supply Voltage	
(V_{CCI})	+3.0V to +3.6V
(V_{CCO})	+1.6V to +2.0V
Ambient Temperature (T_A)	0°C to +85°C
Package Thermal Resistance	
TQFP (θ_{JA})	
–Still-Air	50°C/W
–500lfpm	42°C/W
TQFP (θ_{JC})	20°C/W

DC Electrical Characteristics

$T_A = 0^\circ\text{C}$ to +85°C, unless otherwise noted.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
Power Supply						
V_{CCI}	V_{CC} Core		3.0	3.3	3.6	V
V_{CCO}	V_{CC} Output		1.6	1.8	2.0	V
I_{CCI}	I_{CC} Core			65	90	mA
HSTL						
V_{OH}	Output HIGH Voltage ⁽³⁾		1.0		1.2	V
V_{OL}	Output LOW Voltage ⁽³⁾		0.1		0.4	V
V_{IH}	Input HIGH Voltage		$V_X + 0.1$		1.6	V
V_{IL}	Input LOW Voltage		–0.3		$V_X - 0.1$	V
V_X	Input Crossover Voltage		0.68		0.9	V
I_{IH}	Input HIGH Current		–350		20	μA
I_{IL}	Input LOW Current		–500			μA
V_{IHCMR}	Input HIGH Voltage Common Mode Range(Differential Configuration)		0.6		1.6	V
LVPECL						
V_{IH}	Input HIGH Voltage		$V_{CCI} - 1.145$		$V_{CCI} - 0.895$	V
V_{IL}	Input LOW Voltage		$V_{CCI} - 1.945$		$V_{CCI} - 1.695$	V
I_{IH}	Input HIGH Current		–150		150	μA
I_{IL}	Input LOW Current		–150		150	μA
V_{IHCMR}	Input HIGH Voltage Common Mode Range(Differential Configuration) ⁽⁴⁾		1.2		V_{CCI}	V

Notes:

- Exceeding the absolute maximum rating may damage the device.
- The device is not guaranteed to function outside its operating rating.
- Outputs loaded with 50Ω to ground.
- V_{IHCMR} max varies 1:1 with V_{CCI} . The V_{IHCMR} range is referenced to the most positive side of the differential input signal.

DC Electrical Characteristics

T_A = 0°C to +85°C, unless otherwise noted.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
LVCMOS/LVTTL						
V _{IH}	Input HIGH Voltage		2.0			V
V _{IL}	Input LOW Voltage				0.8	V
I _{IH}	Input HIGH Current		−150		150	μA
I _{IL}	Input LOW Current		−300		300	μA

AC Electrical Characteristics⁽⁵⁾

T_A = 0°C to +85°C, unless otherwise noted.

Symbol	Parameters	0			25°C			85°C			Units
		Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	
V _{Opp}	Differential Output Voltage										mV
	F _{OUT} < 100MHz	600	800		600	800		600	800		
	F _{OUT} < 500MHz	600	700		600	700		600	700		
	F _{OUT} < 750MHz	450	510		450	510		450	510		
t _{PLH} t _{PHL}	Propagation Delay (Differential Configuration)										ps
	LVPECL_CLK to Q	680	800	930	700	820	950	780	920	1070	
	HSTL_CLK to Q	690	830	990	700	850	1000	790	950	1110	
t _{Skew}	Pin-to-Pin Skew ⁽⁶⁾		15	25		15	25		15	25	ps
	Part-to-Part Skew ⁽⁷⁾		100	200		100	200		100	200	
t _{JITTER}	Random Clock Jitter (RMS)		1.4	3		1.4	3		1.4	3	ps
V _{PP}	Input Voltage Swing ⁽⁸⁾										mV
	LVPECL	200			200			200			
	HSTL	200		1900	200		1900	200		1900	
t _S	OE Set-Up Time ⁽⁹⁾	0.5			0.5			0.5			ns
t _H	OE Hold Time	0.5			0.5			0.5			ns
t _r , t _f	Output Rise/Fall Times (20% to 80%) Q, /Q	350		600	350	450	600	350		600	ps

Notes:

- Outputs loaded with 50Ω to ground. Airflow ≥ 500lfpm.
- The Pin-to-Pin skew is defined as the worst-case difference between any two similar delay paths within a single device operating at the same voltage and temperature.
- The Part-to-Part skew is defined as the absolute worst-case difference between any two delay paths on any two devices operating at the same voltage and temperature.
- V_{PP} is the Input Voltage swing required to maintain AC characteristics listed herein. It represents the input voltage swing for CLK or /CLK.
- OE set-up time is defined with respect to the rising edge of the clock. OE HIGH-to-LOW transition ensures outputs remain disabled during the next clock cycle.

Output Waveforms

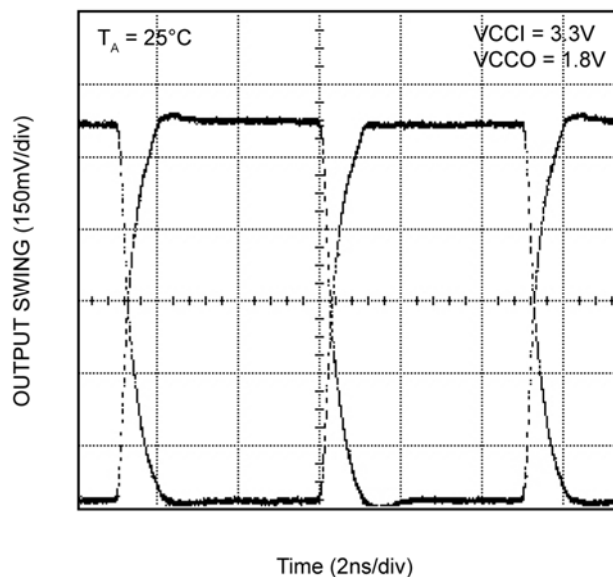


Figure 1. 100MHz Output Waveform

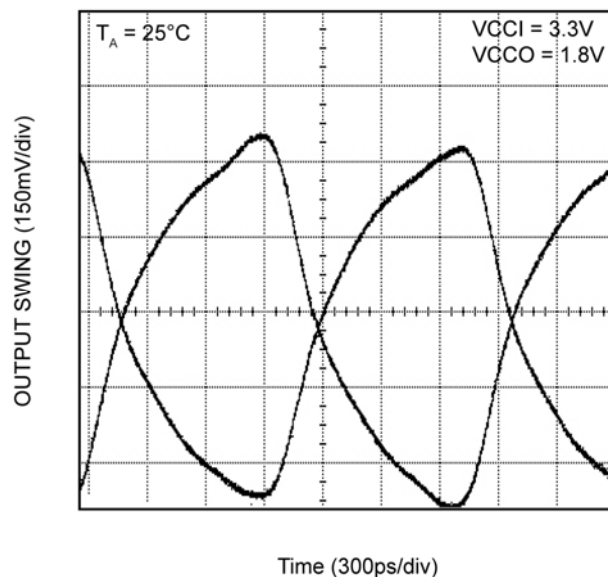
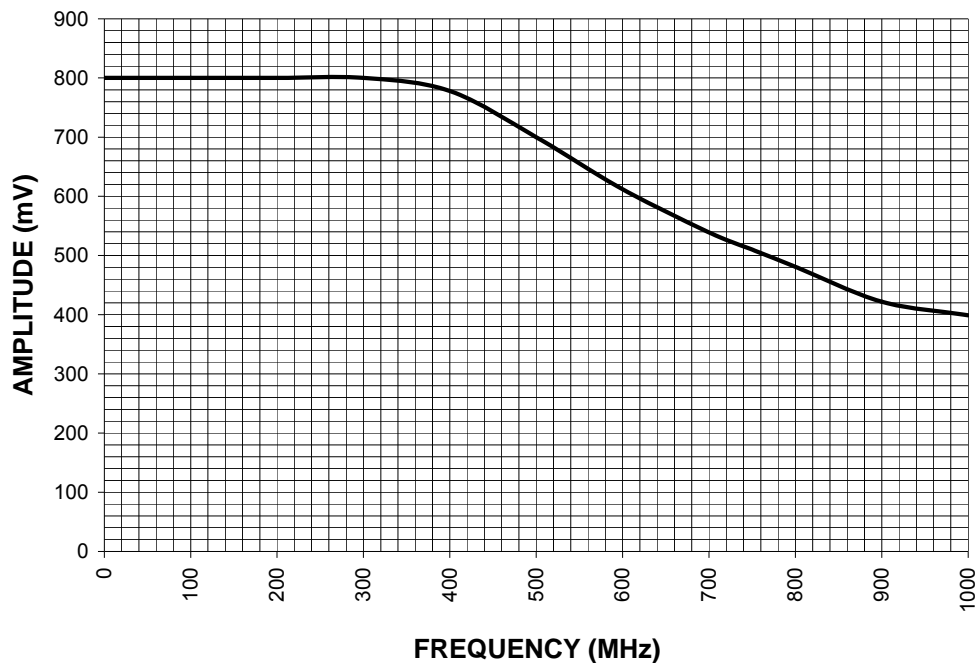


Figure 2. 500MHz Output Waveform

Frequency vs. Amplitude



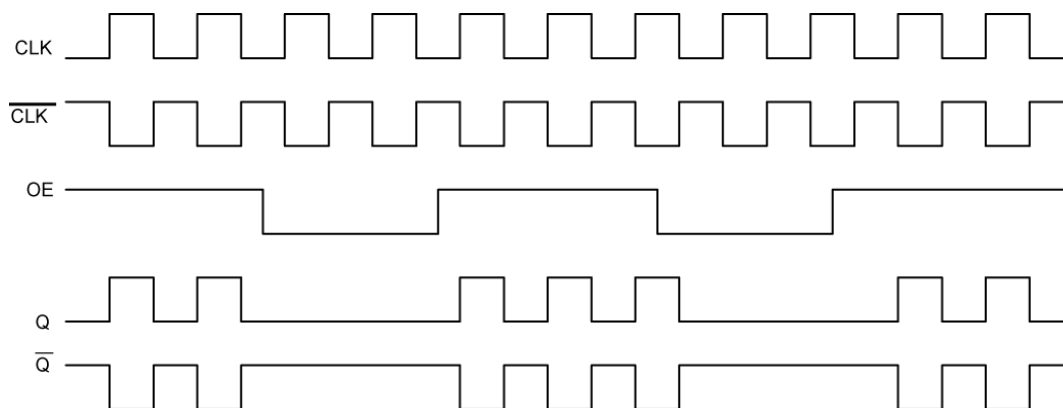
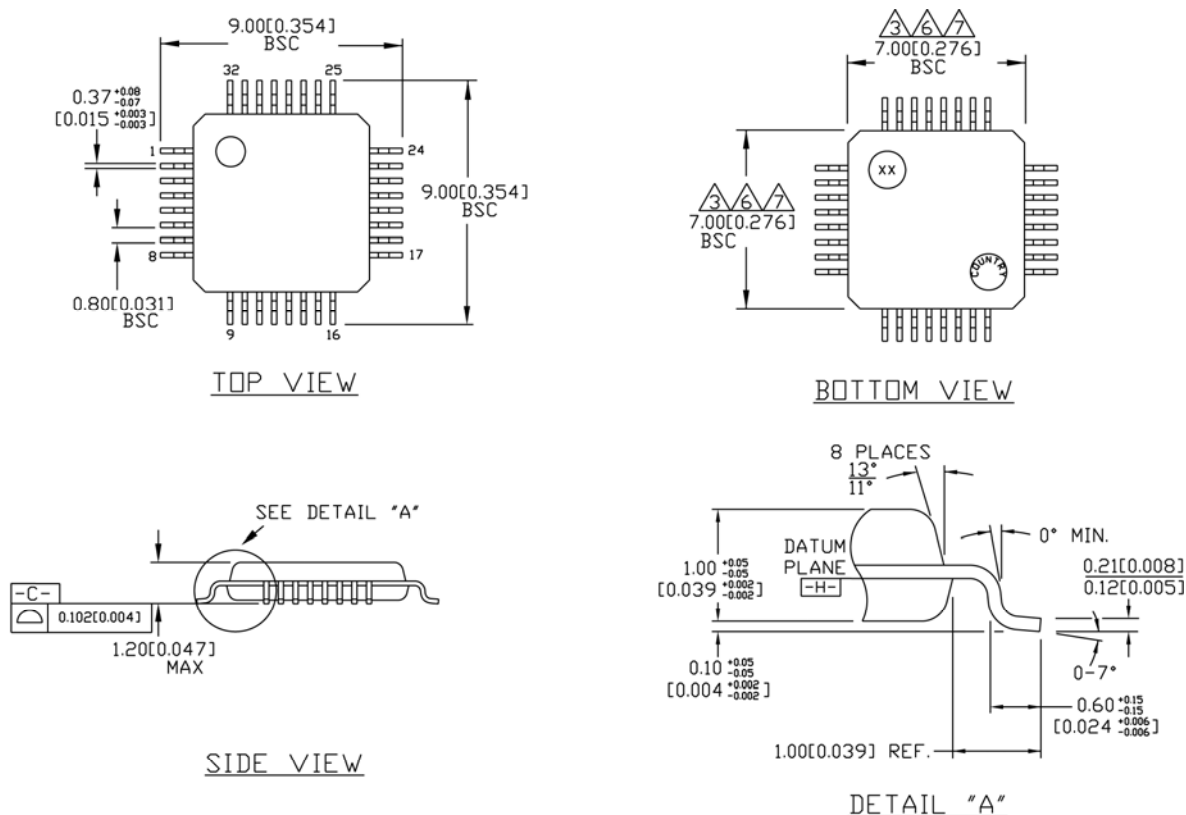


Figure 3. Output Enable Timing Diagram

Package Information



NOTES:

1. DIMENSIONS ARE IN MM[INCHES].
2. CONTROLLING DIMENSION: MM.
3. DIMENSION DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS, EITHER OF WHICH SHALL NOT EXCEED 0.254 [0.010].
4. LEAD DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION.
5. MAXIMUM AND MINIMUM SPECIFICATIONS ARE INDICATED AS FOLLOWS: MAX/MIN.
6. THESE DIMENSIONS TO BE DETERMINED AT DATUM PLANE [H].
7. PACKAGE TOP DIMENSIONS ARE SMALLER THAN BOTTOM DIMENSIONS AND TOP OF PACKAGE WILL NOT OVERHANG BOTTOM OF PACKAGE.

32-Pin TQFP (T32-1)

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